



SamHop Microelectronics Corp.

STU/D1955NL

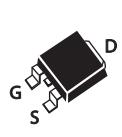
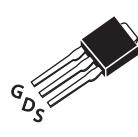
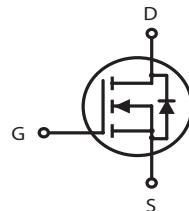
Arp,12 2005 ver1.2

N-Channel Enhancement Mode Field Effect Transistor

PRODUCT SUMMARY		
VDSS	ID	RDS(ON) (mΩ) Max
55V	10A	55 @ VGS = 10V
		80 @ VGS = 4.5V

FEATURES

- Super high dense cell design for low RDS(ON).
- Rugged and reliable.
- TO-252 and TO-251 Package.

STU SERIES
TO-252AA(D-PAK)STD SERIES
TO-251(I-PAK)

ABSOLUTE MAXIMUM RATINGS (TA=25°C unless otherwise noted)

Parameter	Symbol	Limit	Unit	
Drain-Source Voltage Rating	Vspike (d)	60	V	
Drain-Source Voltage	VDS	55	V	
Gate-Source Voltage	VGS	±20	V	
Drain Current-Continuous ^a @ Ta	25°C	ID	10	A
	70°C		8	A
-Pulsed ^b	IDM	23	A	
Drain-Source Diode Forward Current ^a	IS	15	A	
Maximum Power Dissipation ^a	Ta= 25°C	PD	50	W
	Ta=70°C		35	
Operating Junction and Storage Temperature Range	TJ, TSTG	-55 to 175	°C	

THERMAL CHARACTERISTICS

Thermal Resistance, Junction-to-Case	RθJC	3	°C/W
Thermal Resistance, Junction-to-Ambient	RθJA	50	°C/W

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N-Channel ELECTRICAL CHARACTERISTICS (TA = 25 °C unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ ^c	Max	Unit
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V, I _D =250μA	55			V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =44V, V _{GS} =0V		1		μA
Gate-Body Leakage	I _{GSS}	V _{GS} =±20V, V _{DS} =0V		±100		nA
ON CHARACTERISTICS ^b						
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250μA	1.0	1.9	3.0	V
Drain-Source On-State Resistance	R _{D(S(ON))}	V _{GS} =10V, I _D =8A		42	55	m ohm
		V _{GS} =4.5V, I _D =4A		65	80	m ohm
On-State Drain Current	I _{D(ON)}	V _{DS} =5V, V _{GS} =10V	15			A
Forward Transconductance	g _{FS}	V _{DS} =10V, I _D =8A		10		S
DYNAMIC CHARACTERISTICS ^c						
Input Capacitance	C _{ISS}	V _{DS} =30V, V _{GS} =0V f=1.0MHz		635	718	pF
Output Capacitance	C _{OSS}			75	87	pF
Reverse Transfer Capacitance	C _{RSS}			50	57	pF
Gate resistance	R _g	V _{GS} =0V, V _{DS} =0V, f=1.0MHz		2.6		ohm
SWITCHING CHARACTERISTICS ^c						
Turn-On Delay Time	t _{D(ON)}	V _{DD} =30V I _D =8 A V _{GS} =10V R _{GEN} =6 ohm		10.6	13	ns
Rise Time	t _r			5.3	6	ns
Turn-Off Delay Time	t _{D(OFF)}			14.5	17	ns
Fall Time	t _f			9.8	11	ns
Total Gate Charge	Q _g	V _{DS} =15V, I _D =8A, V _{GS} =10V		12.8	14	nC
		V _{DS} =15V, I _D =8A, V _{GS} =5V		7.1	8	nC
Gate-Source Charge	Q _{gs}	V _{DS} =15V, I _D =8A V _{GS} =10V		2.6	3	nC
Gate-Drain Charge	Q _{gd}			3.8	5	nC

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ELECTRICAL CHARACTERISTICS ($T_c=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
DRAIN-SOURCE DIODE CHARACTERISTICS ^a						
Diode Forward Voltage	V_{SD}	$V_{GS} = 0V, I_s = 15A$		1	1.3	V

Notes

- a.Surface Mounted on FR4 Board, $t \leq 10\text{sec}$.
- b.Pulse Test:Pulse Width $\leq 300\mu\text{s}$, Duty Cycle $\leq 2\%$.
- c.Guaranteed by design, not subject to production testing.
- d.Guaranteed when external $R_g=6\text{ ohm}$ and $t_f < t_{f\max}$

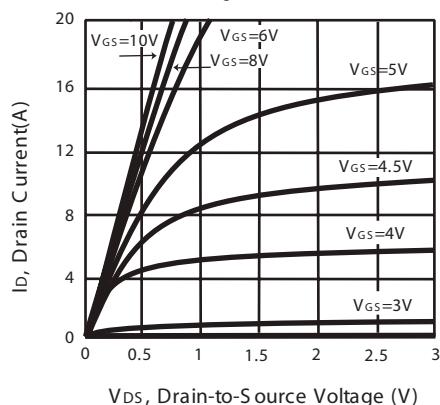


Figure 1. Output Characteristics

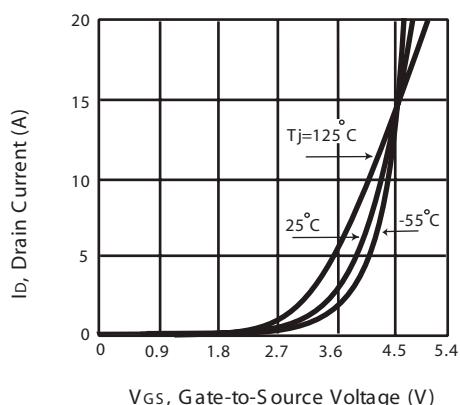


Figure 2. Transfer Characteristics

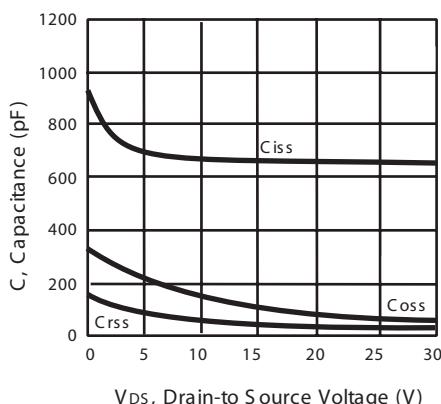


Figure 3. Capacitance

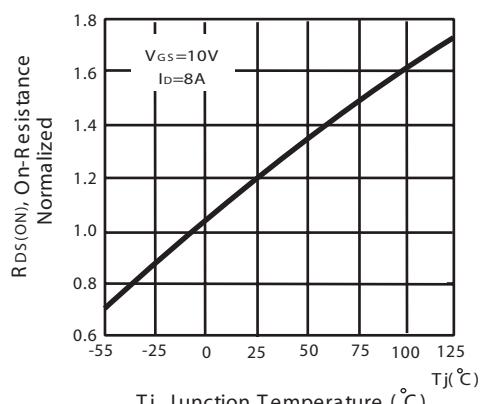


Figure 4. On-Resistance Variation with Drain Current and Temperature

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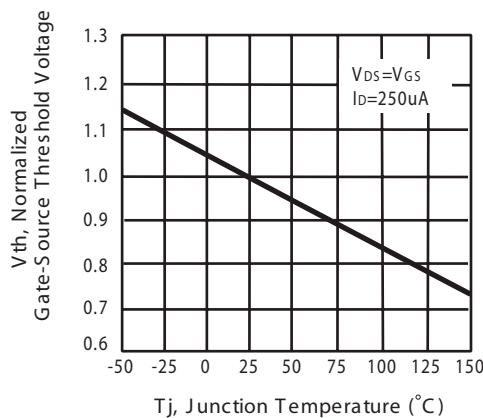


Figure 5. Gate Threshold Variation with Temperature

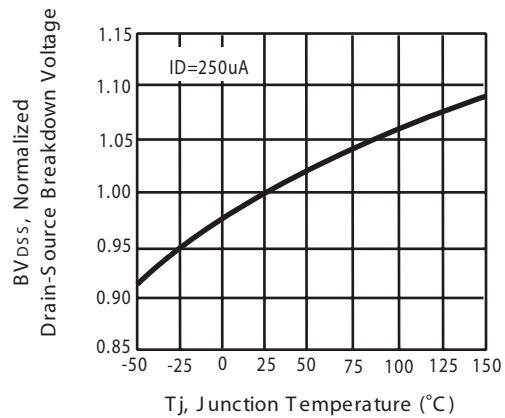


Figure 6. Breakdown Voltage Variation with Temperature

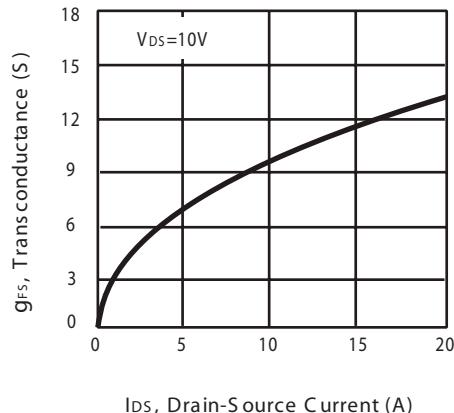


Figure 7. Transconductance Variation with Drain Current

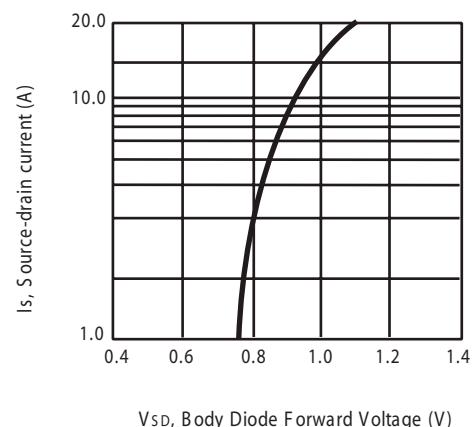


Figure 8. Body Diode Forward Voltage Variation with Source Current

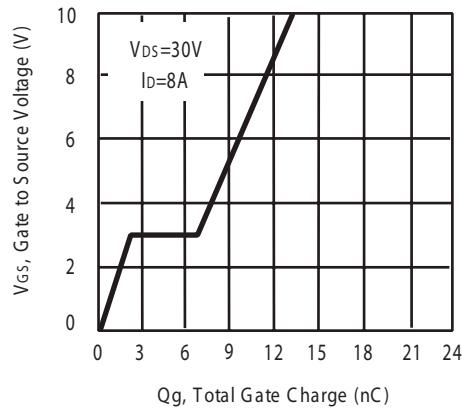


Figure 9. Gate Charge

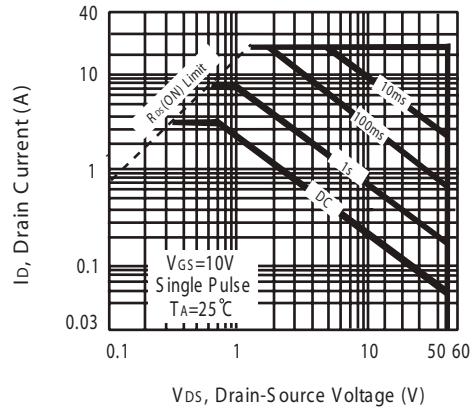
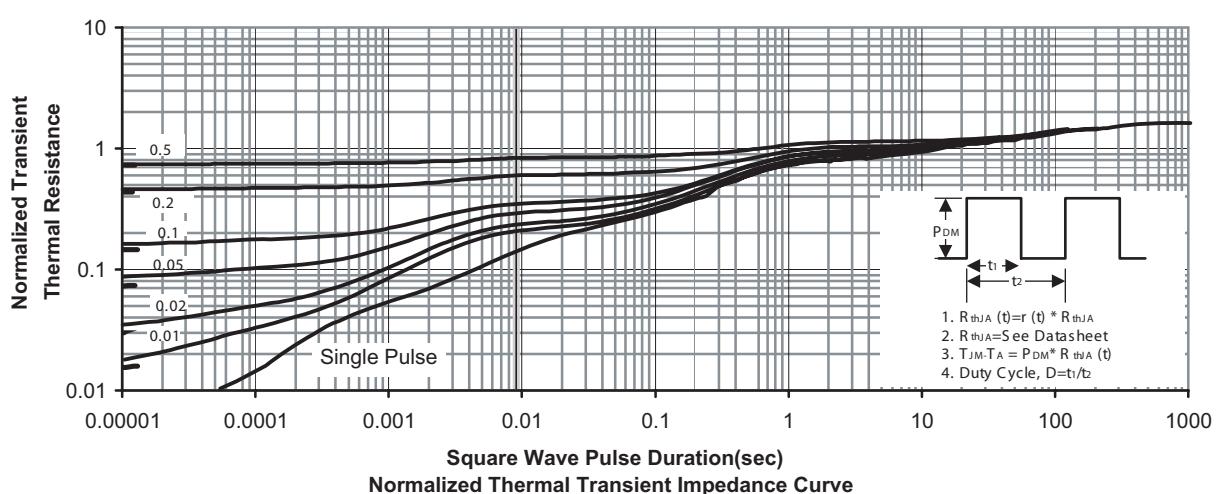
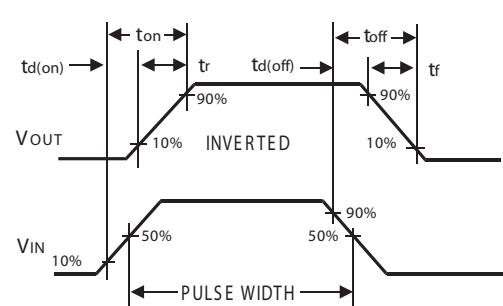
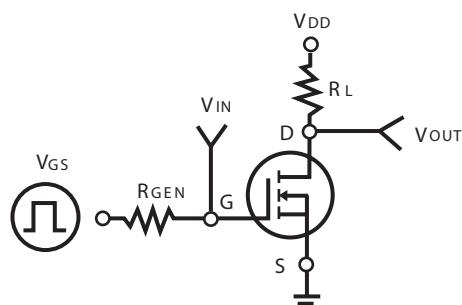


Figure 10. Maximum Safe Operating Area

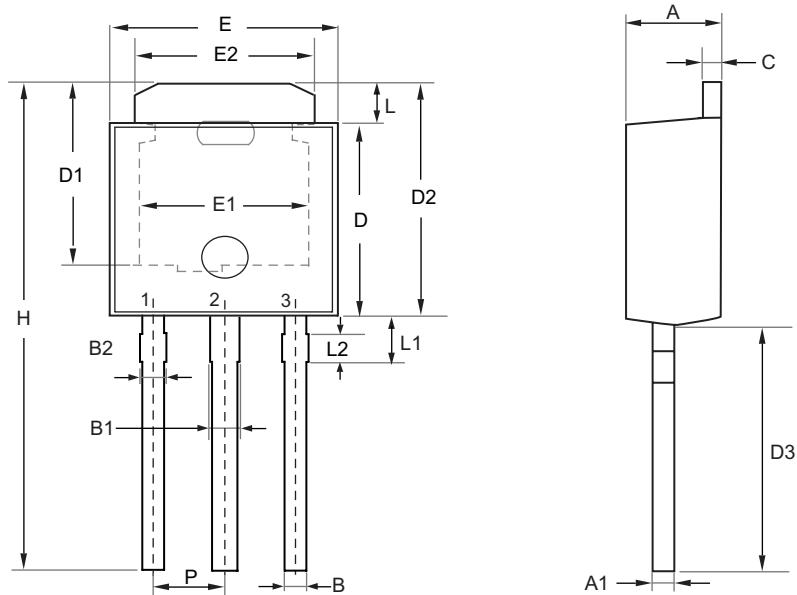
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PACKAGE OUTLINE DIMENSIONS

TO-251



SYMBOL	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	2.100	2.500	0.083	0.098
A1	0.350	0.650	0.014	0.026
B	0.400	0.800	0.016	0.031
B1	0.650	1.050	0.026	0.041
B2	0.500	0.900	0.020	0.035
C	0.400	0.600	0.016	0.024
D	5.300	5.700	0.209	0.224
D1	4.900	5.300	0.193	0.209
D2	6.700	7.300	0.264	0.287
D3	7.000	8.000	0.276	0.315
H	13.700	15.300	0.539	0.602
E	6.300	6.700	0.248	0.264
E1	4.600	4.900	0.181	0.193
E2	4.800	5.200	0.189	0.205
L	1.300	1.700	0.051	0.067
L1	1.400	1.800	0.055	0.071
L2	0.500	0.900	0.020	0.035
P	2.300 BSC		0.091 BSC	

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PACKAGE OUTLINE DIMENSIONS

TO-252

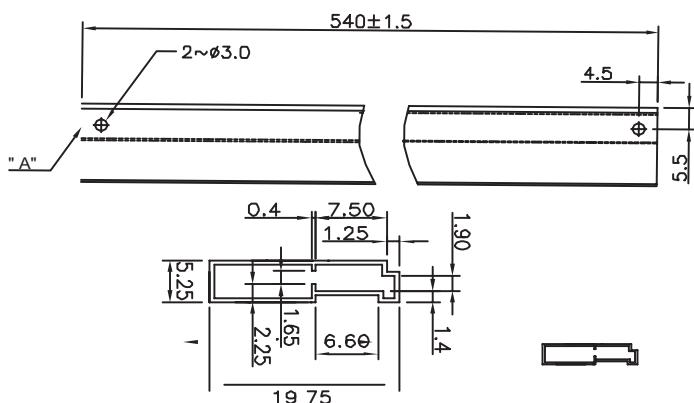
DETAIL "A"

SYMBOLS	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	2.100	2.500	0.083	0.098
A1	0.000	0.200	0.000	0.008
b	0.400	0.889	0.016	0.035
b1	0.770	1.140	0.030	0.045
b2	4.800	5.460	0.189	0.215
C	0.400	0.600	0.016	0.024
D	5.300	6.223	0.209	0.245
D1	4.900	5.515	0.193	0.217
E	6.300	6.731	0.248	0.265
E1	4.400	5.004	0.173	0.197
e	2.290	REF.	0.090	BSC
H	8.900	10.400	0.350	0.409
L	1.397	1.770	0.055	0.070
L1	2.743	REF.	0.108	REF.
L2	0.508	REF.	0.020	REF.
L3	0.890	1.700	0.035	0.067
L4	0.500	1.100	0.020	0.043
θ	0°	10°	0°	10°
θ_1	7°	REF.	7°	REF.

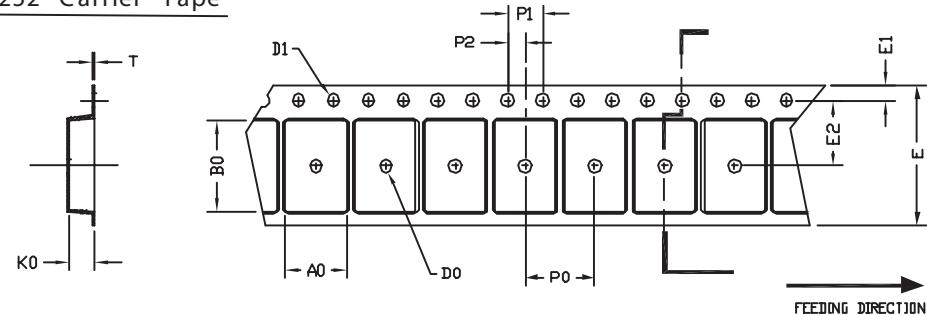
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TO251 Tube/TO-252 Tape and Reel data

TO-251 Tube



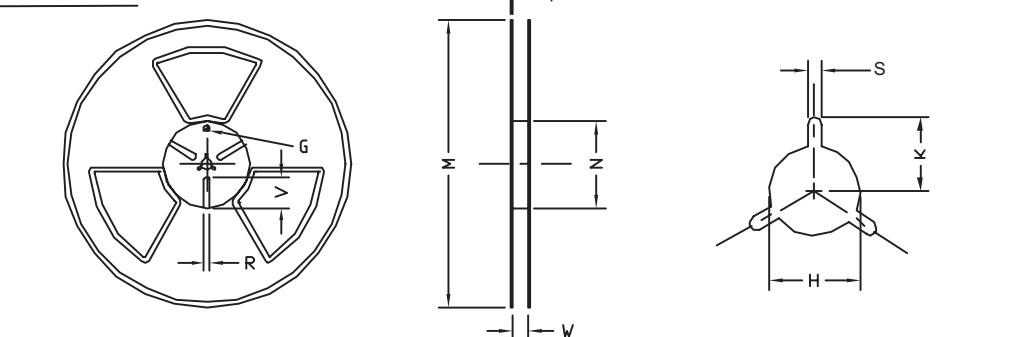
TO-252 Carrier Tape



UNIT:mm

PACKAGE	A0	B0	K0	D0	D1	E	E1	E2	P0	P1	P2	T
TO-252 (16 mm)	6.80 ±0.1	10.3 ±0.1	2.50 ±0.1	φ 2	φ 1.5 + 0.1 - 0	16.0 0.3±	1.75 0.1±	7.5 ±0.15	8.0 ±0.1	4.0 ±0.1	2.0 ±0.15	0.3 ±0.05

TO-252 Reel



UNIT:mm

TAPE SIZE	REEL SIZE	M	N	W	T	H	K	S	G	R	V
16 mm	φ 330	φ 330 ± 0.5	φ 97 ± 1.0	17.0 + 1.5 - 0	2.2	φ 13.0 + 0.5 - 0.2	10.6	2.0 ± 0.5	---	---	---